Form PTO-1595



VER SHEET

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Greg A. Blodgett ハロハ オ・オ・300	Name: Micron Technology
Additional name(s) of conveying party(ies) attached? X No	Internal Address: Street Address: Micron Technology, It 8000 S. Federal Way
3. Nature of Conveyance:	P.O. Box 6
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Internal Address: Atty. Dkt.: M4065.0213/P213	x Enclosed
Attn: Thomas J. D'Amico	Authorized to be charged to deposit account
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08/16/2000 DNGUYEN 00000406 041073 09611769

PATENT REEL: 010993 FRAME: 0707

Docket No.: M4065.0213/P213 Micron No.: 99-0670

ASSIGNMENT AND AGREEMENT

For value received, I, Greg A. Blodgett of Nampa, Idaho, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled VOLTAGE PUMP WITH DIODE FOR PRE-CHARGE, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

PATENT REEL: 010993 FRAME: 0708

Docket No.: M4065.0213/P213 Micron No.: 99-0670

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

RECORDED: 07/07/2000

PATENT REEL: 010993 FRAME: 0709